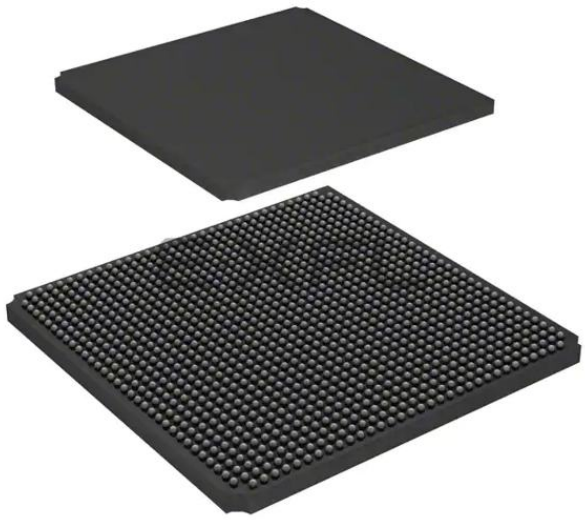
Lattice Semiconductor Corporation - LFE2M70E-7F1152C Datasheet



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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	8375
Number of Logic Elements/Cells	67000
Total RAM Bits	4642816
Number of I/O	436
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m70e-7f1152c

- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADDSUB	4	2	—
MULTADDSUBSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

Table 2-12. PIO Signals List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block flip-flops
CLK0, CLK1	Control from the core	System clocks for input and output blocks
ECLK1, ECLK2	Control from the core	Fast edge clocks
LSR	Control from the core	Local Set/Reset
GSRN	Control from routing	Global Set/Reset (active low)
INCK[2]	Input to the core	Input to Primary Clock Network or PLL reference inputs
DQS	Input to PIO	DQS signal from logic (routing) to PIO
INDD	Input to the core	Unregistered data input to core
INFF	Input to the core	Registered input on positive edge of the clock (CLK0)
IPOS0, IPOS1	Input to the core	Double data rate registered inputs to the core
QPOS0[1], QPOS1[1]	Input to the core	Gearbox pipelined inputs to the core
QNEG0[1], QNEG1[1]	Input to the core	Gearbox pipelined inputs to the core
OPOS0, ONEG0, OPOS2, ONEG2	Output data from the core	Output signals from the core for SDR and DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation
DEL[3:0]	Control from the core	Dynamic input delay control bits
TD	Tristate control from the core	Tristate signal from the core used in SDR operation
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block
DQSXFER	Control from core	Controls signal to the Output block

1. Signals available on left/right/bottom only.
2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm ±1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5[1]	13.0	45.0	2.5[1]
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

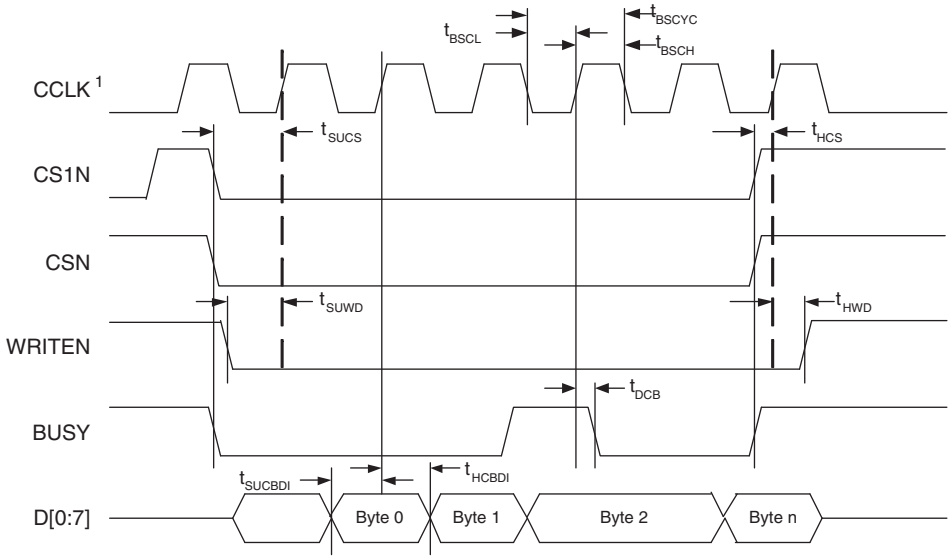
The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

sysI/O Recommended Operating Conditions

Standard	V_{CCIO}			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 3.3[2]	3.135	3.3	3.465	—	—	—
LVCMOS 2.5[2]	2.375	2.5	2.625	—	—	—
LVCMOS 1.8	1.71	1.8	1.89	—	—	—
LVCMOS 1.5	1.425	1.5	1.575	—	—	—
LVCMOS 1.2[2]	1.14	1.2	1.26	—	—	—
LVTTL[2]	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18[2] Class I, II	1.71	1.8	1.89	0.833	0.9	0.969
SSTL2[2] Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3[2] Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL[2] 15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL[2] 18 Class I, II	1.71	1.8	1.89	0.816	0.9	1.08
LVDS[2]	2.375	2.5	2.625	—	—	—
MLVDS25[1]	2.375	2.5	2.625	—	—	—
LVPECL33[1, 2]	3.135	3.3	3.465	—	—	—
BLVDS25[1, 2]	2.375	2.5	2.625	—	—	—
RSDS[1, 2]	2.375	2.5	2.625	—	—	—
SSTL18D_I[2], II[2]	1.71	1.8	1.89	—	—	—
SSTL25D_ I[2], II[2]	2.375	2.5	2.625	—	—	—
SSTL33D_ I[2], II[2]	3.135	3.3	3.465	—	—	—
HSTL15D_ I[2]	1.425	1.5	1.575	—	—	—
HSTL18D_ I[2], II[2]	1.71	1.8	1.89	—	—	—

1. Inputs on chip. Outputs are implemented with the addition of external resistors.
2. Input on this standard does not depend on the value of V_{CCIO}.

Figure 3-15. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-16. sysCONFIG Slave Serial Port Timing

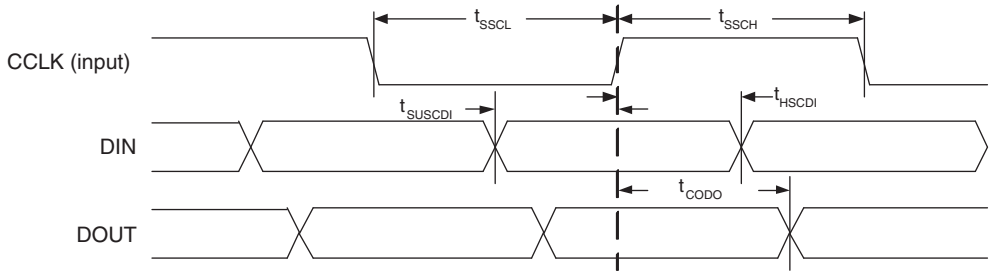
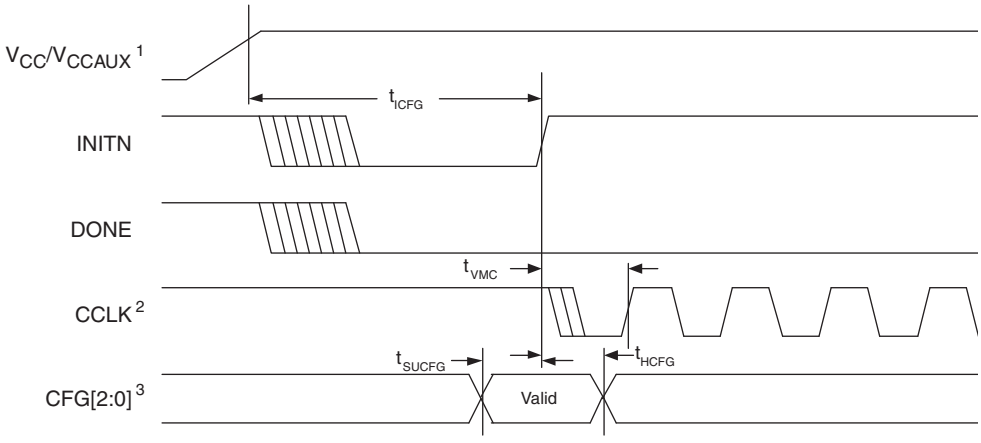


Figure 3-17. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX}, whichever is the last to reach its V_{MIN}.
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

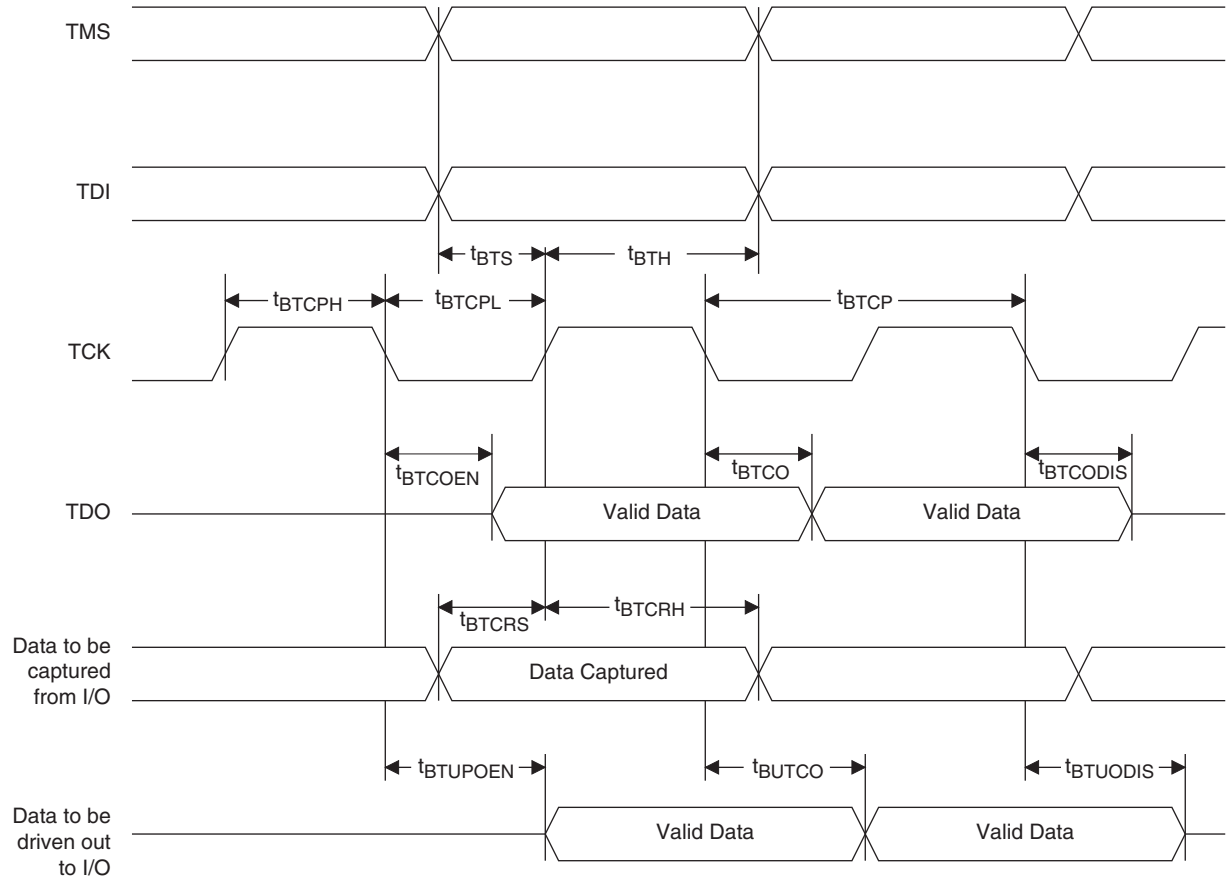
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.A 0.11

Figure 3-21. JTAG Port Timing Waveforms



LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Single Ended User I/O		270	372	410	416	436	416	520
Differential Pair User I/O		135	185	205	208	218	207	260
Configuration	TAP Pins	5	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7	7
Non Configuration	Muxed Pins	69	72	72	75	76	74	78
	Dedicated Pins	3	3	3	3	3	3	3
VCC		16	20	62	44	44	44	44
VCCAUX		8	26	18	16	12	16	12
VCCPLL		4	8	4	4	4	4	4
VCCIO	Bank0	4	5	6	6	7	6	7
	Bank1	3	4	6	6	7	6	7
	Bank2	4	5	9	9	9	9	9
	Bank3	4	5	9	9	9	9	9
	Bank4	4	4	6	6	7	6	7
	Bank5	4	5	6	6	7	6	7
	Bank6	4	5	9	9	9	9	9
	Bank7	4	5	9	9	9	9	9
	Bank8	2	2	2	2	2	2	2
GND, GND0 to GND7		57	80	122	122	134	122	134
NC		31	35	121	63	283	63	199
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	36/18	63/31	56/28	34/17	46/23	34/17	54/27
	Bank1	18/9	18/9	36/18	42/21	34/17	42/21	44/22
	Bank2	30/15	50/25	54/27	70/35	72/36	70/35	80/40
	Bank3	36/18	43/21	44/22	60/30	64/32	60/30	80/40
	Bank4	42/21	24/12	38/19	38/19	40/20	38/19	44/22
	Bank5	28/14	60/30	58/29	40/20	40/20	40/20	46/23
	Bank6	40/20	54/27	60/30	62/31	66/33	62/31	82/41
	Bank7	40/20	60/30	64/32	70/35	74/37	70/35	90/45
	Bank8	0/0	0/0	0/0	0/0	0/0	0/0	0/0
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0	0
	Bank2 (Right Edge)	7	12	13	17	18	17	20
	Bank3 (Right Edge)	9	11	11	15	16	15	20
	Bank4 (Bottom Edge)	0	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0	0
	Bank6 (Left Edge)	10	14	15	15	16	15	20
	Bank7 (Left Edge)	10	15	17	17	18	17	22
	Bank8 (Right Edge)	0	0	0	0	0	0	0

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*
3	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*
4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*
5	PL6A	7	LDQ10	T (LVDS)*	PL6A	7	LDQ10	T (LVDS)*
6	VCCAUX	-			VCCAUX	-		
7	PL6B	7	LDQ10	C (LVDS)*	PL6B	7	LDQ10	C (LVDS)*
8	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*
9	VCCIO7	7			VCCIO7	7		
10	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*
11	GND	-			GND	-		
12	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*
13	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*
14	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T
15	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C
16	VCC	-			VCC	-		
17	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*
18	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*
19	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T
20	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C
21	GND	-			GND	-		
22	VCC	-			VCC	-		
23	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T
24	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C
25	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
26	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*
27	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*
28	PL22A	6			PL22A	6		
29	VCC	-			VCC	-		
30	GND	-			GND	-		
31	VCCIO6	6			VCCIO6	6		
32	TCK	-			TCK	-		
33	TDI	-			TDI	-		
34	TDO	-			TDO	-		
35	VCCJ	-			VCCJ	-		
36	TMS	-			TMS	-		
37	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
38	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
39	VCCAUX	-			VCCAUX	-		
40	PB4A	5	BDQ6	T	PB6A	5	BDQS6	T
41	PB4B	5	BDQ6	C	PB6B	5	BDQ6	C
42	VCCIO5	5			VCCIO5	5		
43	PB6A	5	BDQS6	T	PB12A	5	BDQ15	T
44	PB6B	5	BDQ6	C	PB12B	5	BDQ15	C
45	NC	5			PB16A	5	BDQ15	T

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
T7	PL29B	6	LDQ28	C	PL43B	6	LDQ42	C
T6	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*
AA2	PL31A	6	LDQ28	T	PL45A	6	LDQ42	T
VCCIO	VCCIO6	6			VCCIO6	6		
Y1	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*
AA1	PL31B	6	LDQ28	C	PL45B	6	LDQ42	C
W1	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*
V3	PL30B	6	LDQ28	C (LVDS)*	PL44B	6	LDQ42	C (LVDS)*
GNDIO	GNDIO6	-			GNDIO	-		
V4	PL30A	6	LDQ28	T (LVDS)*	PL44A	6	LDQ42	T (LVDS)*
U5	TDI	-			TDI	-		
U7	TCK	-			TCK	-		
V6	TDO	-			TDO	-		
V5	TMS	-			TMS	-		
T8	VCCJ	-			VCCJ	-		
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
GNDIO	GNDIO5	-			GNDIO	-		
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO	-		
-	-	-			VCCIO5	5		
Y6	PB12A	5	BDQ15	T	PB21A	5	BDQ24	T
W7	PB11A	5	BDQ15	T	PB20A	5	BDQ24	T
Y7	PB12B	5	BDQ15	C	PB21B	5	BDQ24	C
W8	PB11B	5	BDQ15	C	PB20B	5	BDQ24	C
U8	PB14A	5	BDQ15	T	PB23A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
AA7	PB13A	5	BDQ15	T	PB22A	5	BDQ24	T
U9	PB14B	5	BDQ15	C	PB23B	5	BDQ24	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K8	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L12	GND	-			GND	-		
L13	GND	-			GND	-		
L15	GND	-			GND	-		
L8	GND	-			GND	-		
M10	GND	-			GND	-		
M11	GND	-			GND	-		
M12	GND	-			GND	-		
M13	GND	-			GND	-		
M15	GND	-			GND	-		
M8	GND	-			GND	-		
N10	GND	-			GND	-		
N11	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N15	GND	-			GND	-		
N8	GND	-			GND	-		
P14	GND	-			GND	-		
P20	GND	-			GND	-		
P3	GND	-			GND	-		
P9	GND	-			GND	-		
R10	GND	-			GND	-		
R11	GND	-			GND	-		
R12	GND	-			GND	-		
R13	GND	-			GND	-		
U17	GND	-			GND	-		
U6	GND	-			GND	-		
W2	GND	-			GND	-		
W21	GND	-			GND	-		
Y14	GND	-			GND	-		
Y9	GND	-			GND	-		
A1	GND	-			GND	-		
N18	VCCPLL	-			VCCPLL	-		
K6	NC	-			VCCPLL	-		
N6	VCCPLL	-			VCCPLL	-		
J16	NC	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	NC	-			NC	-		
L1	NC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
M2	NC	-			NC	-		
M1	NC	-			NC	-		
N2	NC	-			NC	-		
GND	GNDIO7	-			GNDIO7	-		
M8	VCC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL12A	7	LDQ16		PL18A	7	LDQ22	
L8	PL13A	7	LDQ16	T	PL19A	7	LDQ22	T
K8	PL13B	7	LDQ16	C	PL19B	7	LDQ22	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL14A	7	LDQ16	T (LVDS)*	PL20A	7	LDQ22	T (LVDS)*
K5	PL14B	7	LDQ16	C (LVDS)*	PL20B	7	LDQ22	C (LVDS)*
L7	PL15A	7	LDQ16	T	PL21A	7	LDQ22	T
L5	PL15B	7	LDQ16	C	PL21B	7	LDQ22	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL16A	7	LDQS16	T (LVDS)*	PL22A	7	LDQS22	T (LVDS)*
P2	PL16B	7	LDQ16	C (LVDS)*	PL22B	7	LDQ22	C (LVDS)*
M6	PL17A	7	LDQ16	T	PL23A	7	LDQ22	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL17B	7	LDQ16	C	PL23B	7	LDQ22	C
R1	PL18A	7	LDQ16	T (LVDS)*	PL24A	7	LDQ22	T (LVDS)*
R2	PL18B	7	LDQ16	C (LVDS)*	PL24B	7	LDQ22	C (LVDS)*
M7	PL19A	7	PCLKT7_0/LDQ16	T	PL25A	7	PCLKT7_0/LDQ22	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL19B	7	PCLKC7_0/LDQ16	C	PL25B	7	PCLKC7_0/LDQ22	C
M4	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	PL27A	6	PCLKT6_0/LDQ31	T (LVDS)*
M5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	PL27B	6	PCLKC6_0/LDQ31	C (LVDS)*
N7	PL22A	6	VREF2_6/LDQ25	T	PL28A	6	VREF2_6/LDQ31	T
P9	PL22B	6	VREF1_6/LDQ25	C	PL28B	6	VREF1_6/LDQ31	C
N3	PL23A	6	LDQ25	T (LVDS)*	PL29A	6	LDQ31	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL23B	6	LDQ25	C (LVDS)*	PL29B	6	LDQ31	C (LVDS)*
N5	PL24A	6	LDQ25	T	PL30A	6	LDQ31	T
P7	PL24B	6	LDQ25	C	PL30B	6	LDQ31	C
T1	NC	-			PL31A	6	LDQS31	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	NC	-			PL31B	6	LDQ31	C (LVDS)*
P8	NC	-			PL32A	6	LDQ31	T
P6	NC	-			PL32B	6	LDQ31	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	NC	-			PL33A	6	LDQ31	T (LVDS)*
P4	NC	-			PL33B	6	LDQ31	C (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AJ6	PB16A	5	BDQ15	T
AK6	PB16B	5	BDQ15	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AD10	PB29A	5	BDQ33	T
AF10	PB29B	5	BDQ33	C
AC11	PB30A	5	BDQ33	T
AD11	PB30B	5	BDQ33	C
AG9	PB31A	5	BDQ33	T
AH9	PB31B	5	BDQ33	C
VCCIO	VCCIO5	99		
AE11	PB32A	5	BDQ33	T
AG10	PB32B	5	BDQ33	C
GND	GNDIO5	-		
AJ9	PB33A	5	BDQS33	T
AK9	PB33B	5	BDQ33	C
AF11	PB34A	5	BDQ33	T
AH10	PB34B	5	BDQ33	C
AC12	PB35A	5	BDQ33	T
AE12	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5		
AD12	PB36A	5	BDQ33	T
AF12	PB36B	5	BDQ33	C
AJ10	PB37A	5	BDQ33	T
AK10	PB37B	5	BDQ33	C
GND	GNDIO5	-		
AG11	PB38A	5	BDQ42	T
AH11	PB38B	5	BDQ42	C
AE13	PB39A	5	BDQ42	T
AC13	PB39B	5	BDQ42	C
AF13	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5		
AD13	PB40B	5	BDQ42	C
AJ11	PB41A	5	BDQ42	T
AK11	PB41B	5	BDQ42	C
AD14	PB42A	5	BDQS42	T
GND	GNDIO5	-		
AC14	PB42B	5	BDQ42	C
AG12	PB43A	5	BDQ42	T
AE14	PB43B	5	BDQ42	C
AJ12	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5		
AK12	PB44B	5	BDQ42	C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
G12	PT40B	0		C
E12	PT40A	0		T
VCCIO	VCCIO0	0		
B13	PT39B	0		C
A13	PT39A	0		T
H12	PT38B	0		C
F12	PT38A	0		T
C12	PT37B	0		C
GND	GNDIO0	-		
D12	PT37A	0		T
B12	PT36B	0		C
A12	PT36A	0		T
E11	PT35B	0		C
VCCIO	VCCIO0	0		
G11	PT35A	0		T
F11	PT34B	0		C
H11	PT34A	0		T
C11	PT33B	0		C
D11	PT33A	0		T
B11	PT32B	0		C
GND	GNDIO0	-		
A11	PT32A	0		T
E10	PT31B	0		C
VCCIO	VCCIO0	0		
G10	PT31A	0		T
F10	PT30B	0		C
H10	PT30A	0		T
D10	PT29B	0		C
C10	PT29A	0		T
GND	GNDIO0	-		
VCCIO	VCCIO0	0		
A7	PT16B	0		C
B7	PT16A	0		T
A6	PT15B	0		C
B6	PT15A	0		T
C7	PT14B	0		C
GND	GNDIO0	-		
D7	PT14A	0		T
D8	PT13B	0		C
VCCIO	VCCIO0	0		
E7	PT13A	0		T
C6	PT12B	0		C
D6	PT12A	0		T

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
T1	PL65A	6	LLM0_GDLLT_FB_A	T
T2	PL65B	6	LLM0_GDLLC_FB_A	C
GNDIO	GNDIO6	-		
R7	LLM0_PLLCAP	6		
T6	PL67A	6	LDQ71	T (LVDS)*
T7	PL67B	6	LDQ71	C (LVDS)*
U1	PL68A	6	LDQ71	T
U2	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
T3	PL69A	6	LDQ71	T (LVDS)*
U3	PL69B	6	LDQ71	C (LVDS)*
U6	PL70A	6	LDQ71	T
U5	PL70B	6	LDQ71	C
GNDIO	GNDIO6	-		
V5	PL71A	6	LDQS71	T (LVDS)*
U4	PL71B	6	LDQ71	C (LVDS)*
V1	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		
V3	PL72B	6	LDQ71	C
W1	PL73A	6	LDQ71	T (LVDS)*
Y1	PL73B	6	LDQ71	C (LVDS)*
AA1	PL74A	6	LDQ71	T
GNDIO	GNDIO6	-		
AA2	PL74B	6	LDQ71	C
V4	TCK	-		
Y2	TDI	-		
Y3	TMS	-		
W3	TDO	-		
W4	VCCJ	-		
W5	PB2A	5	BDQ6	T
Y4	PB2B	5	BDQ6	C
W6	PB3A	5	BDQ6	T
V6	PB3B	5	BDQ6	C
AA3	PB4A	5	BDQ6	T
AB2	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5		
T8	PB5A	5	BDQ6	T
U7	PB5B	5	BDQ6	C
GNDIO	GNDIO5	-		
U8	PB6A	5	BDQS6	T
T9	PB6B	5	BDQ6	C
V8	PB7A	5	BDQ6	T
W8	PB7B	5	BDQ6	C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA14	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
W17	PB65A	4	BDQ69	T	PB56A	4	BDQ60	T
AA19	PB65B	4	BDQ69	C	PB56B	4	BDQ60	C
AC15	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T
Y18	PB68B	4	BDQ69	C	PB57B	4	BDQ60	C
AB15	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T
AC16	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C
VCCIO	VCCIO4	4			VCCIO4	4		
AA17	PB60A	4	BDQS60****	T	PB59A	4	BDQ60	T
AB16	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C
GNDIO	GNDIO4	-			GNDIO4	-		
AA15	PB51A	4	BDQS51****	T	PB60A	4	BDQS60	T
W16	PB59B	4	BDQ60	C	PB60B	4	BDQ60	C
Y15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T
AC17	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C
AA18	PB61A	4	BDQ60	T	PB62A	4	BDQ60	T
Y17	PB61B	4	BDQ60	C	PB62B	4	BDQ60	C
-	-	-			VCCIO4	4		
GNDIO	GNDIO4	-			-	-		
W15	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T
AB17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C
GNDIO	GNDIO4	-			GNDIO4	-		
VCCIO	VCCIO4	4			VCCIO4	4		
V17	PB73A	4	BDQ69	T	PB72A	4	BDQ69	T
AA20	PB73B	4	BDQ69	C	PB72B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
AD13	VCC	-			LRC_SQ_VCCRX3	13		
AF14	PB47A	4	BDQ51	T	LRC_SQ_HDINP3	13		T
AE13	NC	-			LRC_SQ_VCCIB3	13		
AE14	PB41A	4	VREF2_4/BDQ42	T	LRC_SQ_HDINN3	13		C
AD16	VCC	-			LRC_SQ_VCCTX3	13		
AF17	PB51B	4	BDQ51	C	LRC_SQ_HDOUTP3	13		T
AF16	NC	-			LRC_SQ_VCCOB3	13		
AE17	PB50A	4	BDQ51	T	LRC_SQ_HDOUTN3	13		C
AD17	VCC	-			LRC_SQ_VCCTX2	13		
AE18	PB53B	4	BDQ51	C	LRC_SQ_HDOUTN2	13		C
AD18	NC	-			LRC_SQ_VCCOB2	13		
AF18	PB53A	4	BDQ51	T	LRC_SQ_HDOUTP2	13		T
AD14	VCC	-			LRC_SQ_VCCRX2	13		
AE15	PB48B	4	BDQ51	C	LRC_SQ_HDINN2	13		C
AD15	NC	-			LRC_SQ_VCCIB2	13		
AF15	PB47B	4	BDQ51	C	LRC_SQ_HDINP2	13		T
AD19	VCC	-			LRC_SQ_VCCP	13		
AC19	PB57B	4	BDQ60	C	LRC_SQ_REFCLKP	13		T
AB19	PB59A	4	BDQ60	T	LRC_SQ_REFCLKN	13		C
AE19	VCCAUX	-			LRC_SQ_VCCAUX33	13		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F11	VCCIO0	0			VCCIO0	0		
J13	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	1		
D18	VCCIO1	1			VCCIO1	1		
F16	VCCIO1	1			VCCIO1	1		
J14	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
G25	VCCIO2	2			VCCIO2	2		
L21	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M25	VCCIO2	2			VCCIO2	2		
N18	VCCIO2	2			VCCIO2	2		
P18	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R25	VCCIO3	3			VCCIO3	3		
T21	VCCIO3	3			VCCIO3	3		
Y25	VCCIO3	3			VCCIO3	3		
AA16	VCCIO4	4			VCCIO4	4		
AC18	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V14	VCCIO4	4			VCCIO4	4		
AA11	VCCIO5	5			VCCIO5	5		
V13	VCCIO5	5			VCCIO5	5		
AE12	VCCIO5	5			VCCIO5	5		
AE7	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
P9	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R2	VCCIO6	6			VCCIO6	6		
T6	VCCIO6	6			VCCIO6	6		
Y2	VCCIO6	6			VCCIO6	6		
G2	VCCIO7	7			VCCIO7	7		
L6	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M2	VCCIO7	7			VCCIO7	7		
N9	VCCIO7	7			VCCIO7	7		
AC24	VCCIO8	8			VCCIO8	8		
U17	VCCIO8	8			VCCIO8	8		
J11	VCCAUX	-			VCCAUX	-		
J12	VCCAUX	-			VCCAUX	-		
J15	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
M18	VCCAUX	-			VCCAUX	-		
M9	VCCAUX	-			VCCAUX	-		
R18	VCCAUX	-			VCCAUX	-		
R9	VCCAUX	-			VCCAUX	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
D2	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
G6	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7	LDQ15	T
D1	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-		
G5	PL15A	7	LDQS15	T (LVDS)*
G4	PL15B	7	LDQ15	C (LVDS)*
K7	PL16A	7	LDQ15	T
K8	PL16B	7	LDQ15	C
E1	PL17A	7	LDQ15	T (LVDS)*
F2	PL17B	7	LDQ15	C (LVDS)*
F1	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-		
G3	PL18B	7	LDQ15	C
GNDIO	GNDIO7	-		
H5	PL25A	7	LDQ23	T (LVDS)*
H4	PL25B	7	LDQ23	C (LVDS)*
J5	PL26A	7	LDQ23	T
J4	PL26B	7	LDQ23	C
GNDIO	GNDIO7	-		
G2	PL28A	7	LDQ32	T (LVDS)*
G1	PL28B	7	LDQ32	C (LVDS)*
L9	PL29A	7	LDQ32	T
L7	PL29B	7	LDQ32	C
K6	PL30A	7	LDQ32	T (LVDS)*
K5	PL30B	7	LDQ32	C (LVDS)*
L8	PL31A	7	LDQ32	T
L6	PL31B	7	LDQ32	C
GNDIO	GNDIO7	-		
H3	PL32A	7	LDQS32	T (LVDS)*
H2	PL32B	7	LDQ32	C (LVDS)*
N8	PL33A	7	LDQ32	T
M9	PL33B	7	LDQ32	C
J3	PL34A	7	LDQ32	T (LVDS)*
-	-	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AA1	PL81A	6	LDQS81	T (LVDS)*
GNDIO	GNDIO6	-		
AA2	PL81B	6	LDQ81	C (LVDS)*
Y3	PL82A	6	LDQ81	T
AB1	PL82B	6	LDQ81	C
VCCIO	VCCIO6	6		
Y9	PL83A	6	LDQ81	T (LVDS)*
Y8	PL83B	6	LDQ81	C (LVDS)*
Y7	PL84A	6	LDQ81	T
AA7	PL84B	6	LDQ81	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
AB2	PL95A	6	LDQ99	T (LVDS)*
AB3	PL95B	6	LDQ99	C (LVDS)*
AA5	PL96A	6	LDQ99	T
AA6	PL96B	6	LDQ99	C
AB4	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6		
AB5	PL97B	6	LDQ99	C (LVDS)*
AA8	PL98A	6	LDQ99	T
AA9	PL98B	6	LDQ99	C
AC1	PL99A	6	LLM0_GPLLT_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-		
AC2	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AC4	PL100A	6	LLM0_GPLLT_FB_A/LDQ99	T
AC3	PL100B	6	LLM0_GPLLC_FB_A/LDQ99	C
VCCIO	VCCIO6	6		
AC7	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AC6	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AC5	PL102A	6	LLM0_GDLLT_FB_A/LDQ99	T
AD3	PL102B	6	LLM0_GDLLC_FB_A/LDQ99	C
GNDIO	GNDIO6	-		
AB8	LLM0_PLLCAP	6		
AD2	PL104A	6		T
AD1	PL104B	6		C
AE2	TCK	-		
AE1	TDI	-		
AF2	TMS	-		
AF1	TDO	-		
AG1	VCCJ	-		
AH1	LLC_SQ_VCCRX3	14		
AK2	LLC_SQ_HDINP3	14		T
AJ1	LLC_SQ_VCCIB3	14		

LatticeECP2 S-Series Devices, Lead-Free Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144C	90	1.2V	-5	Lead-Free TQFP	144	Com	6
LFE2-6SE-6TN144C	90	1.2V	-6	Lead-Free TQFP	144	Com	6
LFE2-6SE-7TN144C	90	1.2V	-7	Lead-Free TQFP	144	Com	6
LFE2-6SE-5FN256C	190	1.2V	-5	Lead-Free fpBGA	256	Com	6
LFE2-6SE-6FN256C	190	1.2V	-6	Lead-Free fpBGA	256	Com	6
LFE2-6SE-7FN256C	190	1.2V	-7	Lead-Free fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144C	93	1.2V	-5	Lead-Free TQFP	144	Com	12
LFE2-12SE-6TN144C	93	1.2V	-6	Lead-Free TQFP	144	Com	12
LFE2-12SE-7TN144C	93	1.2V	-7	Lead-Free TQFP	144	Com	12
LFE2-12SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	12
LFE2-12SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	12
LFE2-12SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	12
LFE2-12SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	12
LFE2-12SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	12
LFE2-12SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	12
LFE2-12SE-5FN484C	297	1.2V	-5	Lead-Free fpBGA	484	Com	12
LFE2-12SE-6FN484C	297	1.2V	-6	Lead-Free fpBGA	484	Com	12
LFE2-12SE-7FN484C	297	1.2V	-7	Lead-Free fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	20
LFE2-20SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	20
LFE2-20SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	20
LFE2-20SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2-20SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2-20SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	20
LFE2-20SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2-20SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2-20SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2-20SE-5FN672C	402	1.2V	-5	Lead-Free fpBGA	672	Com	20
LFE2-20SE-6FN672C	402	1.2V	-6	Lead-Free fpBGA	672	Com	20
LFE2-20SE-7FN672C	402	1.2V	-7	Lead-Free fpBGA	672	Com	20

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Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5F484I	304	1.2V	-5	fpBGA	484	IND	20
LFE2M20E-6F484I	304	1.2V	-6	fpBGA	484	IND	20
LFE2M20E-5F256I	140	1.2V	-5	fpBGA	256	IND	20
LFE2M20E-6F256I	140	1.2V	-6	fpBGA	256	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5F672I	410	1.2V	-5	fpBGA	672	IND	35
LFE2M35E-6F672I	410	1.2V	-6	fpBGA	672	IND	35
LFE2M35E-5F484I	303	1.2V	-5	fpBGA	484	IND	35
LFE2M35E-6F484I	303	1.2V	-6	fpBGA	484	IND	35
LFE2M35E-5F256I	140	1.2V	-5	fpBGA	256	IND	35
LFE2M35E-6F256I	140	1.2V	-6	fpBGA	256	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5F900I	410	1.2V	-5	fpBGA	900	IND	50
LFE2M50E-6F900I	410	1.2V	-6	fpBGA	900	IND	50
LFE2M50E-5F672I	372	1.2V	-5	fpBGA	672	IND	50
LFE2M50E-6F672I	372	1.2V	-6	fpBGA	672	IND	50
LFE2M50E-5F484I	270	1.2V	-5	fpBGA	484	IND	50
LFE2M50E-6F484I	270	1.2V	-6	fpBGA	484	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5F1152I	436	1.2V	-5	fpBGA	1152	IND	70
LFE2M70E-6F1152I	436	1.2V	-6	fpBGA	1152	IND	70
LFE2M70E-5F900I	416	1.2V	-5	fpBGA	900	IND	70
LFE2M70E-6F900I	416	1.2V	-6	fpBGA	900	IND	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5F1152I	520	1.2V	-5	fpBGA	1152	IND	100
LFE2M100E-6F1152I	520	1.2V	-6	fpBGA	1152	IND	100
LFE2M100E-5F900I	416	1.2V	-5	fpBGA	900	IND	100
LFE2M100E-6F900I	416	1.2V	-6	fpBGA	900	IND	100